

STP40NF03L

N-channel 30V - 0.018Ω - 40A - TO-220 STripFET™ Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STP40NF03L	30V	<0.022Ω	40A

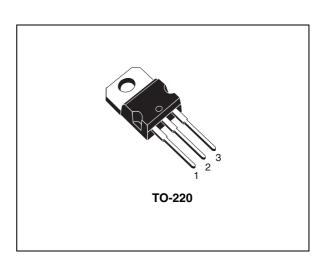
■ Low threshold device

Description

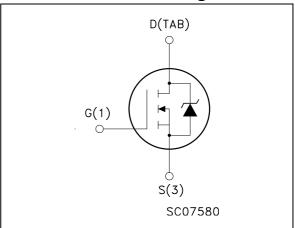
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging	
STP40NF03L	P40NF03L	TO-220	Tube	

Contents STP40NF03L

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STP40NF03L Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS}	Gate- source voltage	± 16	V
I _D	Drain current (continuous) at T _C = 25°C	40	Α
I _D	Drain current (continuous) at T _C = 100°C	28	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	160	Α
P _{tot}	Total dissipation at T _C = 25°C	70	W
	Derating Factor	0.46	W/°C
E _{AS} (2)	Single pulse avalanche energy	250	mJ
T _{stg}	Storage temperature		°C
T _j	Max. operating junction temperature	-55 to 175	

^{1.} Pulse width limited by safe operating area.

Table 2. Thermal data

Rthj-case	Thermal resistance junction-case max 2.1		°C/W
Rthj-amb	Thermal resistance junction-ambient max	62.5	°C/W
T _J	Maximum lead temperature for soldering purpose	300	°C

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^{2.} Starting T_i = 25 °C, I_D = 20A, V_{DD} = 15V

Electrical characteristics STP40NF03L

2 Electrical characteristics

(T_{CASE} =25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = max ratings V_{DS} = max ratings, T_{C} = 125°C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ±16V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.7	2.5	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 20A$ $V_{GS} = 4.5V, I_D = 20A$		0.018 0.028	0.022 0.035	Ω Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} (1)	Forward transconductance	V _{DS} = 10V, I _D = 20A		20		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1MHz,$ $V_{GS} = 0$		770 255 60		pF pF pF
$\begin{array}{c} t_{\text{d(on)}} \\ t_{\text{r}} \\ t_{\text{d(off)}} \\ t_{\text{f}} \end{array}$	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} = 15V, I_D = 20A R_G = 4.7 Ω V_{GS} = 4.5V (see <i>Figure 13</i>)		14 80 25 16		ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 15V$, $I_D = 40A$, $V_{GS} = 4.5V$ (see <i>Figure 14</i>)		10.5 4 4.5	15	nC nC nC

^{1.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5%.

Table 5. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				40 160	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 40A, V _{GS} = 0			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 40A$, $di/dt = 100A/\mu s$, $V_{DD} = 15V$, $T_j = 150^{\circ}C$ (see <i>Figure 15</i>)		34.5 30 2		ns nC A

- 1. Pulse width limited by safe operating area.
- 2. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STP40NF03L

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

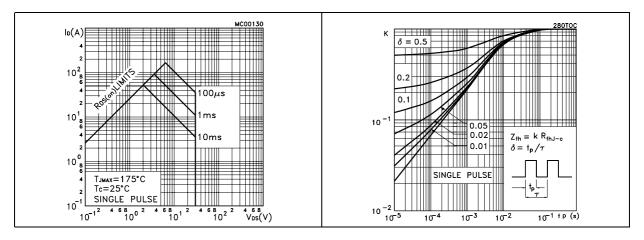


Figure 3. Output characteristics

Figure 4. Transfer characteristics

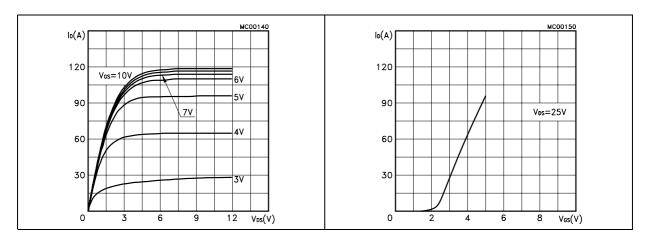
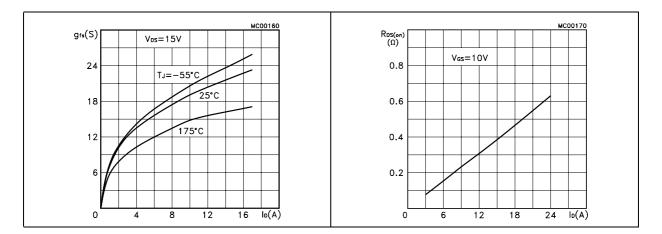


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



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Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

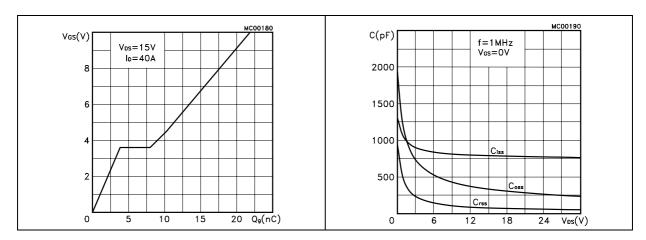


Figure 9. Normalized gate threshold voltage vs. temperature

Figure 10. Normalized on resistance vs. temperature

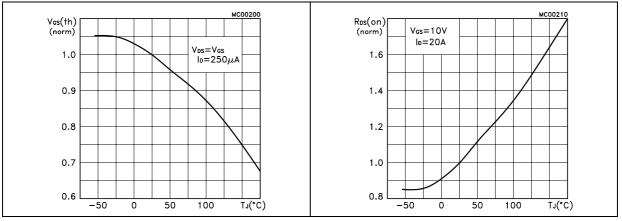
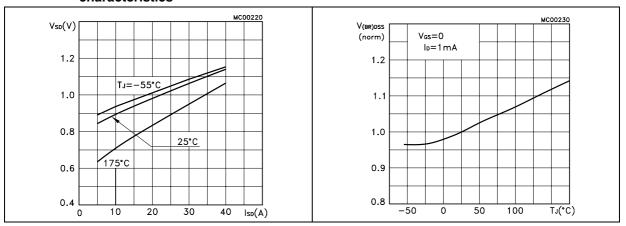


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized B_{VDSS} vs. temperature



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Test circuit STP40NF03L

3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

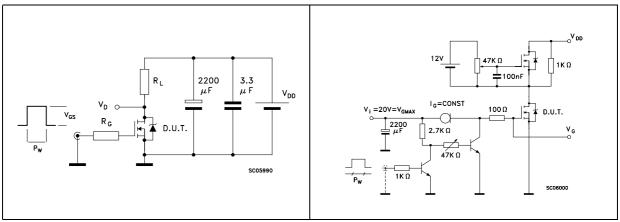


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

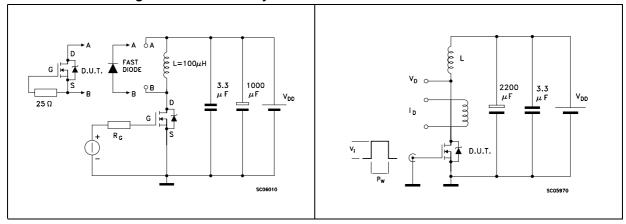
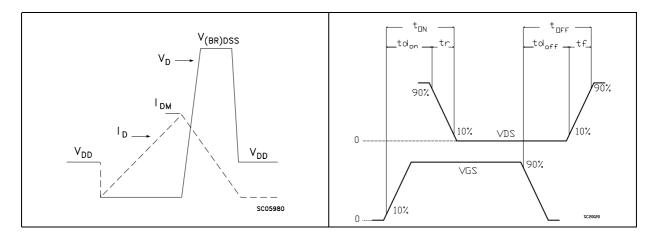


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



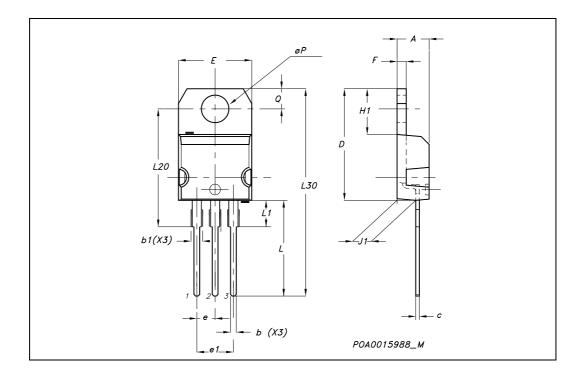
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-220 MECHANICAL DATA

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øΡ	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



STP40NF03L Revision history

5 Revision history

Table 6. Revision history

Date	Revision	Changes
09-Sep-2004	1	Preliminary version
21-Jun-2005	2	Complete version with curves
16-Aug-2006	3	New template, no content change
21-Feb-2007	4	Typo mistake on page 1

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